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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Ko et al.

Serial No.: 09/711,324

Filed: November 13, 2000

**For:** ETCHANT WITH SELECTIVITY  
FOR DOPED SILICON DIOXIDE OVER  
UNDOPED SILICON DIOXIDE AND  
SILICON NITRIDE, PROCESSES WHICH  
EMPLOY THE ETCHANT, AND  
STRUCTURES FORMED THEREBY

Confirmation No.: 7008

Examiner: K. Chen

Group Art Unit: 1765

Attorney Docket No.: 2269-3526.4US  
(97-1136.4)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

December 4, 2002  
Date

Signature

Deidra J. Pfeil  
Name (Type/Print)

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AND INTERFERENCES  
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TC 1700  
2002 DEC 13 PM 4: 27

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO/SB/08 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a). The listed documents were cited by the Office in co-pending application Serial No. 09/585,682, filed on June 1, 2000, and directed to a related invention.

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In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56(b) exists.

U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 5,759,888	06/02/1998	Wang et al.
US - 6,051,870	04/18/2000	Ngo
US - 6,239,017	05/29,2001	Lou et al.

Applicants offer to supply any explanation or discussion of the documents that the Examiner feels is necessary or desirable and which is requested.

Certification Pursuant to 37 C.F.R. § 1.97(e)

This Supplemental Information Disclosure Statement is filed after the mailing date of a final Office Action under 37 C.F.R. § 1.113 or a Notice of Allowance under 37 C.F.R. § 1.311, but before or simultaneously with payment of the issue fee. I hereby certify that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the person signing the certification after making reasonable inquiry, was known to any individual designated in § 1.56(c) more than three months prior to the filing of this information disclosure statement. The fee pursuant to 37 C.F.R. § 1.17(p) for consideration of this Supplemental Information Disclosure Statement is enclosed.

Serial No. 09/711,324

Respectfully submitted,



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Date: December 4, 2002

BGP/ps:djp

Enclosures: Form PTO-1449 or PTO/SB/08

Cited Documents

\$180.00 fee

Document in ProLaw